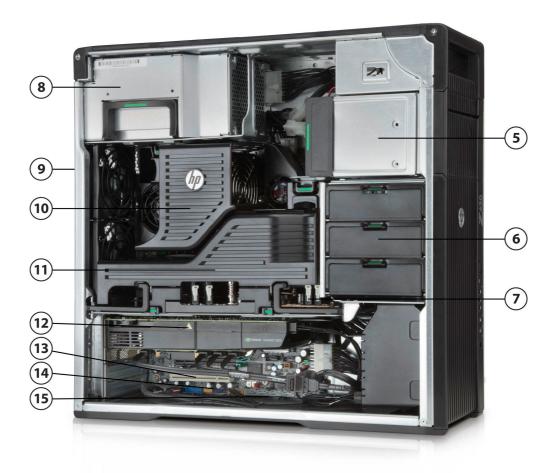
Overview



- 1. 2 External 5.25" Bays (shown with optional slot-load optical drive)
- 2. Power Button
- 3. HDD Activity LED
- 4. Front I/O: 1 USB 2.0, 2 USB 3.0, 1 Headphone, 1 Microphone, 1 1394a



Overview



- 5. 2 External 5.25" Bays
- 6. 3 Internal 3.5" Bays
- 7. 12 DIMM Slots for DDR3 ECC Memory
- 8. 800W, 90% Efficient Power Supply
- 9. Rear I/O: Rear Power Button & LED, PS/2 Ports, 1 1394a, 15. 10 SATA Ports 4 USB 2.0, 2 USB 3.0, 2 RJ-45 to Integrated GbE, 1 Audio Line In, 1 Audio Line Out, 1 Microphone
- 10. Intel Xeon Processors E5-1600 family or E5-2600 family

- 11. 2<sup>nd</sup> CPU & Memory Module
- 12. 2 PCle x16 Gen3 Slots
- 1 PCle x8 Gen3, 1 PCle x8(x4) Gen2, 1 PCle x4(x1) Gen2, 1 PCI Slot
- 14. 6 Internal USB 2.0 Ports

Form Factor	Minitower
Operating Systems	Preinstalled:
	<ul> <li>Genuine Windows 7® Ultimate 64-bit*</li> <li>Genuine Windows 7® Professional 64-bit*</li> </ul>



### Overview

- Genuine Windows 7® Professional 32-bit\*
- HP Installer Kit for Linux (includes drivers for 64-bit OS versions of RHEL 5 & 6 and SUSE Linux Enterprise Desktop 11)
- Red Hat Enterprise Linux Desktop (Preinstall NOT available; 1 year paper license only)

### Supported:

- Genuine Windows® 7 Enterprise 32/64
- SUSE Linux Enterprise Desktop 11

Notes: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux\_hardware\_matrix

**Notes**: \*Systems may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See <a href="http://www.microsoft.com/windows/windows-7/">http://www.microsoft.com/windows/windows-7/</a> for details.

### Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MHz)	QPI Speed (GT/s)	Hyper- Threading	Featuring Intel® vPro™ Technology	Intel® Turbo Boost Technology <sup>1</sup>	TDP (W)
Intel® Xeon® E5-2690 processor	8	2.9	20	1600	8.0	Y	Y	4, 9	135
Intel Xeon E5-2680 processor	8	2.7	20	1600	8.0	Y	Y	4, 8	130
Intel Xeon E5-2670 processor	8	2.6	20	1600	8.0	Y	Y	4, 7	115
Intel Xeon E5-2667 processor	6	2.9	15	1600	8.0	Y	Y	3, 6	130
Intel Xeon E5-2665 processor	8	2.4	20	1600	8.0	Y	Y	4, 7	115
Intel Xeon E5-2660 processor	8	2.2	20	1600	8.0	Y	Y	5, 8	95
Intel Xeon E5-2650 processor	8	2.0	20	1600	8.0	Y	Y	4, 8	95
Intel Xeon E5-2643 processor	4	3.3	10	1600	8.0	Y	Y	1, 2	130
Intel Xeon E5-2640 processor	6	2.5	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2630 processor	6	2.3	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2620 processor	6	2.0	15	1333	7.2	Y	Y	3, 5	95
Intel Xeon E5-2609 processor	4	2.4	10	1066	6.4	N	Y	N/A	80
Intel Xeon E5-2603 processor	4	1.8	10	1066	6.4	N	Y	N/A	80
Intel® Xeon® E5-1660 processor	6	3.3	15	1600	-	Y	Y	3, 6	130
Intel Xeon E5-1650 processor	6	3.2	12	1600	-	Y	Y	3, 6	130



### Overview

Intel Xeon E5-1620 processor	4	3.6	10	1600	-	Y	Y	2, 3	130
Intel Xeon E5-1607 processor	4	3.0	10	1066	-	N	Y	N/A	130
Intel Xeon E5-1603 processor	4	2.8	10	1066	-	N	Y	N/A	130

<sup>1</sup>The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A.

NOTE: Z620 systems configured with E5-1600 series processors may not add a 2nd processor. To support two processors, E5-2600 series processor must be chosen.

### Available Processor Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor\_number/ for details

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

### Additional Details

- Intel® Sandy Bridge Architecture
- Intel® C602 Chipset
- Intel® Xeon® processor E5-2600 product family Intel® Xeon® processor E5-1600 product family (Sandy Bridge, Socket R)
- Up to 8.0GT/s QPI support with two QPI links between processors
- 4-channel per processor 1066/1333/1600 MHz DDR3 memory\* subsystem
- Up to 96 GB Memory capacity with up to 12 DIMM slots and 8 GB DIMMs
- PCI Express I/O and dual PCle x16 Gen3 graphics support
- Dual Integrated Intel Gigabit LAN on Motherboard (LOM)
- 2 channels of Serial ATA (SATA) 6.0 Gb/s and 8 channels of SATA 3.0 Gb/s natively supported internally
- SATA RAID\*\* 0, 1, 5, and 10 support standard on motherboard
- SAS RAID 0, 1, and 10 supported using the LSI 9212-4i 6Gb/s controller
- SATA optical drives
- High Definition integrated audio with internal speaker
- 800W 90% efficient power supply
- ENERGY STAR® qualification and energy-saving features available on selected configurations (Not supported by Linux)
- Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3) standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply.

\*Each processor supports up to 4 channels of DDR3 memory. To realize full performance at least 1



### Overview

Overview	
	DIMM must be inserted into each channel. To get full 8 channel support, 2 processors MUST be installed.
	**SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID,
	provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for
	RAID capabilities with Linux.
Form Factor	Rackable Minitower
Color	Brushed aluminum & black
I/O Expansion Slots	Slot 1 (top):
<u>'</u>	PCI Express Gen2 x4(1)*
	Full-height, Half-length
	(not available when 2nd CPU/Memory Module is installed)
	Slot 2:
	PCI Express Gen3 x16
	Full-height, Full-length (with extender)
	Slot 3:
	PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)
	i on-neight, i on-length (with extender)
	Slot 4:
	PCI Express Gen3 x8 with open-ended connector**
	Full-height, Full-length (with extender)
	Slot 5:
	PCI Express Gen3 x16
	Full-height, Full-length (with extender)
	Slot 6:
	PCI 32bit/33MHz Full-height, Full-length (with extender)
	i on-neight, i on-length (with extender)
	* x <number> = number of lanes or size of the physical/mechanical connector.</number>
	(number) = number of lanes supported electrically. Typically communicated as x# mechanical,
	x(#)electrical.
	** open-ended connector allow a greater bandwidth (e.g. x16) card to be installed physically into a lower
Mana Chanana Dana /	bandwidth connector/slot.
Mass Storage Bays (see Storage section for more	Total bays = 5
details)	
Internal Bays	3 internal 3.5" bays (with acoustic dampening rail assemblies pre-installed)
External Bays	2 external 5.25" bays
,	(4th HDD occupies one external bay)
Front I/O	2 USB 3.0, 1 USB 2.0, 1 Headphone, 1 Microphone, 1 IEEE 1394a
Rear I/O	2 USB 3.0, 4 USB 2.0, 2 RJ-45 integrated Gigabit LAN, 2 PS/2, 1 Audio Line-In, 1 Audio Line-Out, 1
	Microphone
	Serial supported with optional connector on PCI bracket cabled to system board connector
Internal USB	6 USB 2.0
Chassis Dimensions (H x W x D)	44.45 x 17.15 x 46.48 cm (17.5 x 6.75 x 18.3 in)



### Overview

System Weight	Actual weight depends upon configuration Minimum config: 15.5 kg (34.2 lb) Typical config: 17.9 kg (39.4 lb) Maximum config: 22.6 kg (49.9 lb)				
Temperature	Operating:	5° to 35° C (40° to 95° F)			
	Non-operating	-40° to 60° C (-40° to 140° F)			
Humidity	Operating:	8% to 85% relative humidity, non-condensing			
	Non-operating	8% to 90% relative humidity, non-condensing			
Maximum Altitude (non-	Operating:	3,048m (10,000ft)			
pressurized)	Non-operating	9,144m (30,000ft)			
Power Supply		Tool-free 800W 90% Efficient wide-ranging, active Power Factor Correction The Power Supply Efficiency Report for this product may be found at this link: TBD			
Interfaces Supported	10-channel SATA Interface (2 6 Gb/s, 4 @ 3 Gb/s) for use SAS interface supported USB 3.0, USB 2.0, IEEE 139				
Hard Drive Controllers Supported	SATA and SAS controllers				
Backup Devices		patible DAT tape drives, LTO tape drives and RDX Removable Disk Backup http://www.hp.com/go/connect			
Workstation ISV	See the latest list of certification	ons at			
Certifications	http://www.hp.com/united-st	ates/campaigns/workstations/partnerships.html			



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Intel Xeon E5-2600 Series - CTO	Comigured	IXII	TTOTTIBET	140103
	Intel® Xeon® Processor E5-2603 4C 1.80GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2609 4C 2.40GHz	Y	N		
	Intel® Xeon® Processor E5-2620 6C 2.00GHz	Y	Ν		
	Intel® Xeon® Processor E5-2630 6C 2.30GHz	Y	Ν		
	Intel® Xeon® Processor E5-2640 6C 2.50GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2643 4C 3.30GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2650 8C 2.00GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2660 8C 2.20GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2665 8C 2.40GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2667 6C 2.90GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2670 8C 2.60GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2680 8C 2.70GHz	Υ	Ν		
	Intel® Xeon® Processor E5-2690 8C 2.90GHz	Υ	Ν		
	Intel Xeon E5-1600 Series				
	Intel® Xeon® Processor E5-1660 6C 3.30GHz	Υ	Ν		
	Intel® Xeon® Processor E5-1650 6C 3.20GHz	Υ	Ν		
	Intel® Xeon® Processor E5-1620 4C 3.60GHz	Υ	Ν		
	Intel® Xeon® Processor E5-1607 4C 3.00GHz	Υ	Ν		
	Intel® Xeon® Processor E5-1603 4C 2.80GHz	Υ	Ν		
	Intel Xeon E5-2600 Series - Z620 AMO				
	Z620 Xeon E5-2603 4C 1.80 10MB 1066 CPU2	Ν	Υ	A6S72AA	
	Z620 Xeon E5-2609 4C 2.40 10MB 1066 CPU2	Ν	Υ	A6S73AA	
	Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	Ν	Υ	A6S74AA	
	Z620 Xeon E5-2630 6C 2.30 15MB 1333 CPU2	Ν	Υ	A6S75AA	
	Z620 Xeon E5-2640 6C 2.50 15MB 1333 CPU2	Ν	Υ	A6S76AA	
	Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	Ν	Υ	A6S77AA	
	Z620 Xeon E5-2650 8C 2.00 20MB 1600 CPU2	Ν	Υ	A6S78AA	
	Z620 Xeon E5-2660 8C 2.20 20MB 1600 CPU2	Ν	Υ	A6S79AA	
	Z620 Xeon E5-2665 8C 2.40 20MB 1600 CPU2	Ν	Υ	A6S80AA	
	Z620 Xeon E5-2667 6C 2.90 15MB 1600 CPU2	Ν	Υ	A6S81AA	
	Z620 Xeon E5-2670 8C 2.60 20MB 1600 CPU2	Ν	Υ	A6S82AA	
	Z620 Xeon E5-2680 8C 2.70 20MB 1600 CPU2	Ν	Υ	A6S83AA	
	Z620 Xeon E5-2690 8C 2.90 20MB 1600 CPU2	Ν	Υ	A6S84AA	

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor number/ for details.



### Supported Components

Multi-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance.

Z620 processor AMO kits include:

- 2nd CPU/Memory Module (riser)
- processor
- heat sink

SAS Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
	HP SAS (Serial Attached SCSI) Hard Drives for HP Workst	tations				
	HP 300GB SAS 10K SFF HDD	Υ	Υ	A2Z20AA		
	HP 600GB SAS 10K SFF HDD	Υ	Υ	A2Z21AA		
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU967AA		
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	LU968AA		
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA		
	Sub-Section Description/Notes					
	NOTE: SAS Controller add-in card required					
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstations					
	250GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ034AA		
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA		
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA		
	2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA		
	3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QF298AA		
SATA Solid State Drives	HP Solid State Drives (SSDs) for Workstations					
	HP 128GB SATA SSD	Υ	Υ	A3D25AA		
	HP 256GB SATA SSD	Υ	Υ	A3D26AA		
	HP 160GB SATA SSD	Υ	Υ	LZ704AA		
	HP 300GB SATA SSD	Υ	Υ	LZ069AA		
	For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 3 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 of system disk is reserved for system recovery software (Vista). Up to 4 drives are allowed. The 4th drive will occupy one of the external 5.25" bays.					



### Supported Components

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes				
	Integrated SATA 6.0 Gb/s Controller								
	Integrated SATA 6.0 Gb/s Controller	Υ	Ν		Two ports				
	Integrated SATA 3.0 Gb/s Controller								
	Integrated SATA 3.0 Gb/s Controller	Υ	Ν		Eight ports				
	Factory integrated RAID on motherboard for SATA	drives							
	RAID 0 Configuration - Striped Array	Υ	Ν		See note 1				
	RAID 1 Configuration - Mirrored Array	Υ	Ν		See note 1				
	RAID 10 Configuration - Striped/Mirrored Array	Υ	Ν		See note 1				
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	Ν		See note 1				
	LSI 9212 4-Port SAS 6Gb/s RAID Card								
	LSI 9212 4-Port SAS 6Gb/s RAID Card	Υ	Υ	XP310AA					
	LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card and iBBU08 Battery Backup Unit								
	LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card	Ν	Υ	WE465AA					
	Optional: LSI iBBU08 Battery Backup Unit for LSI 9260-8i	Ν	Υ	LA783AA					
	All RAID arrays must be less than 2 TB in size								

All RAID arrays must be less than 2 TB in size

NOTE 1: Requires 2 identical hard drives (speeds, capacity, interface). RAID 1 does not support a 3rd HDD. No Linux support for SATA RAID.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. Please visit: http://www.hp.com/support/linux hardware matrix for details.

### LSI RAID Definitions:

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux hardware matrix for details



Supported Components

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
	Professional 2D	J				
	AMD FirePro 2270 512MB Graphics Card	Υ	Υ	LA524AA		4
	NVIDIA NVS300 512MB PCle Graphics Card	Υ	Υ	XP612AA		4
	NVIDIA NVS 310 512MB Graphics Card	Υ	Υ	A7U59AA		3
	NVIDIA Quadro NVS 450 512 MB PCle Graphics Card	Υ	Y	FH519AA	2nd card must be NVS 450 or NVS 310	2 X
	Entry 3D					
	NVIDIA Quadro 410 512MB Graphics	Υ	Υ	A7U60AA		2
	NVIDIA Quadro 600 1GB Graphics Card	Υ	Υ	WS093AA		2
	AMD FirePro V3900 1GB Graphics Card	Υ	Υ	A6R69AA		2
	AMD FirePro V4900 1GB Graphics Card	Υ	Υ	A3J92AA		2
	Mid-range 3D					
	NVIDIA Quadro 2000 1GB Graphics Card	Υ	Υ	WS094AA		2
	AMD FirePro V5900 2GB Graphics <b>High End 3D</b>	Υ	Υ	LS992AA		2
	AMD FirePro V7900 2GB Graphics	Υ	Υ	LS993AA		2
	NVIDIA Quadro 4000 2GB Graphics Card	Υ	Υ	WS095AA		2
	NVIDIA Quadro 5000 2.5GB Graphics Card	Υ	Υ	WS096AA		2
	NVIDIA Quadro 6000 6GB Graphics Card	Y	Υ	WS097AA		2
High Performance GPU Computing			Factory	Option	Option Kit Part	

Configured Υ QB035AA See note 1 NVIDIA Tesla C2075 Compute Processor NOTE 1: Tesla C2075 does not have an operational graphics output and is only supported in

combination with NVIDIA Quadro 410 1st graphics.

Number Support Notes

Kit

### Supported Components

Memory CTO Option Kit Part Support Notes
Number

DDR3-1600 ECC Unbuffered DIMMs - CTO

2GB DDR3-1600 ECC Unbuffered RAM

4GB DDR3-1600 ECC Unbuffered RAM

DDR3-1600 ECC Registered DIMMs - CTO

4GB DDR3-1600 ECC Registered RAM

8GB DDR3-1600 ECC Registered RAM

### Sub-Section Description/Notes

The Z620 has a four-channel memory architecture. Four channels are associated with each processor. For optimal performance, populate a DIMM in each channel.

### **AMO**

### DDR3-1600 ECC Registered DIMMs - AMO

4GB DDR3-1600 ECC Registered RAM A2Z49AA
8GB DDR3-1600 ECC Registered RAM A2Z51AA

DDR3-1600 ECC Unbuffered DIMMs - AMO

 HP 2GB (1x2GB) DDR3-1600 ECC RAM
 A2Z47AA

 HP 4GB (1x4GB) DDR3-1600 ECC RAM
 A2Z48AA

**NOTE**: Although all of these memory selections incorporate 1600MHz memory modules, the speed at which they operate is dependent upon the processor.

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel/Realtek HD ALC262 Audio	Υ	Ν		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive (non-Lightscribe version)	Υ	Υ	AR629AA	See note 1
	HP 16X DVD+/-RW SuperMulti SATA Drive (non- Lightscribe)	Υ	Υ	QS208AA	
	HP Slot Load DVD+/-RW Drive	Υ	Ν		
	HP Blu-ray Writer	Υ	Υ	AR482AA	See note 2
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA	
	HP DX115 Removable Drive Enclosure				
	HP DX115 Carrier with 160GB SATA HDD	Ν	Υ	FZ577AA	
	HP DX115 Removable HDD Frame/Carrier	Ν	Υ	FZ576AA	
	HP DX115 Removable HDD Carrier	Ν	Υ	NB792AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other



### Supported Components

copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive.

NOTE 2: Cannot be ordered in combination with another Blu-ray Writer.

Controller Cards		Factory Configured	•	Option Kit Part Number	Support Notes
	HP IEEE 1394b FireWire PCle Card	Υ	Υ	NK653AA	

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel 82579LM PCIe GbE Controller	Υ	Ν		See note 2
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Υ	Υ	FS215AA	See notes 1 and 2
	Intel Gigabit CT Desktop NIC	Ν	Υ	FH969AA	See note 2
	HP NC360T PCI Express Dual Port Gigabit NIC	Ν	Υ	KU004AA	See note 2

**NOTE 1:** This is a PCI Express card based on the Broadcom 5761 chip. This card does not support DASH 1.1 manageability on this platform.

NOTE 2: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical			Option Kit		
Security		Factory Configured	Option Kit	Part Number	Support Notes
	Security Cable with Kensington Lock	Ν	Υ	PC766A	
	HP (CMT) Solenoid Lock	Ν	Υ	DE618A	
	HP Solenoid Hood Lock & Hood Sensor	Υ	Ν		
	HP Z6/Z8 Adjustable Sliding Rail Rack Kit	Ν	Υ	NN124AA	



### Supported Components

Input Devices				Option Kit	
·		Factory	Option	Part	
		Configured	Kit	Number Support Note	es:
	HP PS/2 Standard Keyboard	Υ	Υ	DT527A	
	HP USB Standard Keyboard	Υ	Υ	DT528A	
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
	HP USB Laser Mouse	Υ	Υ	GW405AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP USB Smart Card Keyboard	Υ	Υ	ED707AA	
	HP 2.4GHz Wireless Keyboard & Mouse	Ν	Υ	NB896AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	Ν	Υ	ET424AA	
	HP SpaceExplorer 3D USB Controller	Ν	Υ	RY429AA	
	HP SpacePilot 3D USB Intelligent Controller	Ν	Υ	EF390AA	

Other Hardware				Option Kit	
		Factory Configured	Option Kit	Part Number	Support Notes
	HP Workstation Mouse Pad	Y	N	Nomber	Japan only.
	HP Power Cord Kit	Ν	Υ	DM293A	1 /
	HP eSATA PCI Cable Kit	Ν	Υ	GM110AA	
	HP Serial Port Adapter	Ν	Υ	PA716A	
	HP Internal USB Port Kit	Ν	Υ	EM165AA	
	HP Optical Bay HDD Mounting Bracket	Υ	Υ	NQ099AA	For 3.5" HDDs
	HP Energy Star Enabled Configuration	Υ	Ν		

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Υ		See note 1
	HP Remote Graphics Software (RGS) V5	Υ	Ν		See note 2
	HP ProtectTools Security	Υ	Ν		See note 3
	MS Office Home & Business 2010	Υ	Ν		See note 4
	HP Power Assistant	Υ	Ν		
	Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Υ	Ν		
	Intervideo WinDVD (DVD player/burner software)	Υ	Ν		
	PDF Complete - Trial Edition	Υ	Ν		

NOTE 1: Available as a free download here: www.hp.com/go/performanceadvisor

NOTE 2: Supports both 32 and 64 bit versions of Windows 7 Professional and Enterprise, Windows XP Professional and Enterprise, and RHEL V6

NOTE 3: Must select as a Configure to Order option. Delivered as a "Drop in the Box" CD

NOTE 4: Must select as a Configure to Order option



### Supported Components

Operating Systems Support Notes

Genuine Windows® 7 Ultimate 64- See Note 1

bit

Genuine Windows® 7 Professional See Note 1

64-bit

Genuine Windows® 7 Professional See Note 1

32-bit

HP Linux Installer Kit

Red Hat Enterprise Linux (RHEL) See Note 2

Workstation - Paper License (1yr)

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details.

NOTE 2: This second OS must be ordered with the HP Linux Intaller Kit as the first OS.



System Board	
System Board Form Factor	Main System Board: 24 x 31 cm 9.6 x 12.2 inches 2nd CPU/Memory Board (optional): 14.9 x 29.2 cm 5.85 x 11.50 inches
Processor Socket	LGA2011 1st CPU on system board 2nd CPU on optional 2nd CPU/Memory Module
CPU Bus Speed	QPI: Up to 8.0GT/second, depending on processor
Chipset	Intel C602 Chipset
Super I/O Controller	Nuvoton NPCD379H (SIO-12)
Memory Expansion Slots	8 on system board(CPU0) + 4 on optional 2nd CPU/Memory Module (CPU1)
Memory Type Supported	DDR3, UDIMM (Unbuffered), ECC: 2GB and 4GB DDR3, RDIMM (Registered), ECC: 4GB and 8GB
Memory Modes	NUMA (Non-Uniform Memory Architecture), Memory Node Interleave
Memory Speed Supported	1066, 1333, & 1600MHz



		Single Processor								
			CPU0 Front Slots			CPU0 Rear Slots				
Capacity (GB)	Туре	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	
2	UDIMM	2GB								
4	UDIMM	2GB							2GB	
6	UDIMM	2GB		2GB					2GB	
8	UDIMM	2GB		2GB			2GB		2GB	
12	UDIMM	2GB	2GB	2GB			2GB	2GB	2GB	
16	UDIMM	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	
16	UDIMM	4GB		4GB			4GB		4GB	
16	RDIMM	4GB		4GB			4GB		4GB	
24	UDIMM	4GB	2GB	4GB	2GB	2GB	4GB	2GB	4GB	
32	UDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	
32	RDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	
32	RDIMM	8GB		8GB			8GB		8GB	
48	RDIMM	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	
64	RDIMM	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	
Slot Loa	d Order	1	5	3	7	8	4	6	2	

System Technical Specifications

			Dual Processor										
				U0 Slots			CPU0 Rear Slots			CPU1 Front Slots		CPU1 Rear Slots	
Capacity (GB)	Туре	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	DIMM 1	DIMM 2	DIMM 3	DIMM 4
4	UDIMM	2GB								2GB			
8	UDIMM	2GB							2GB	2GB			2GB
12	UDIMM	2GB		2GB					2GB	2GB	2GB		2GB
16	UDIMM	2GB		2GB		r	2GB	19	2GB	2GB	2GB	2GB	2GB
20	UDIMM	2GB	2GB	2GB			2GB	2GB	2GB	2GB	2GB	2GB	2GB
24	UDIMM	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB	2GB
32	UDIMM	4GB		4GB			4GB		4GB	4GB	4GB	4GB	4GB
32	RDIMM	4GB		4GB			4GB		4GB	4GB	4GB	4GB	4GB
48	UDIMM	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB	4GB
48	RDIMM	8GB		4GB			4GB		8GB	8GB	4GB	4GB	8GB
64	RDIMM	8GB		8GB	2.		8GB		8GB	8GB	8GB	8GB	8GB
80	RDIMM	8GB	4GB	8GB	4GB	4GB	8GB	4GB	8GB	8GB	8GB	8GB	8GB
96	RDIMM	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB
Slot Loa	d Order	1	9	5	11	12	7	10	3	2	6	8	4

NOTE: CPU0 is located on the main system board. CPU1 (optional) is located on an add-in riser card.

Maximum Memory	Supports up to 96GB
Memory Configuration (Supported)	<ul> <li>Not all memory configurations possible are represented above.</li> <li>Only ECC DIMMs are supported.</li> <li>Do not install memory modules into memory slots if corresponding processor is not installed.</li> <li>Dual processor configurations with memory modules installed for only one processor is not supported.</li> <li>UDIMM (Unbuffered) and RDIMM (Registered) memory cannot be mixed. All memory installed in the system must be either UDIMM or RDIMM.</li> </ul>
PCI Express Connectors	Slot 1 (top): PCI Express Gen2 x4(1)* Full-height, Half-length (not available when 2nd CPU/Memory Module is installed)  Slot 2: PCI Express Gen3 x16 Full-height, Full-length (with extender)  Slot 3: PCI Express Gen2 x8(4)* with open-ended connector** Full-height, Full-length (with extender)



system recnnical specification	JII3				
	Slot 4: PCI Express Gen3 x8 with open-ended connector** Full-height, Full-length (with extender)  Slot 5: PCI Express Gen3 x16 Full-height, Full-length (with extender)				
	(number) = number of lanes support x(#)electrical.	or size of the physical/mechanical connector.  In ted electrically. Typically communicated as x# mechanical,  In teater bandwidth (e.g. x16) card to be installed physically  In teater bandwidth (e.g. x16) card to be installed physically  In teater bandwidth (e.g. x16) card to be installed physically  In teater bandwidth (e.g. x16) card to be installed physically  In teater bandwidth (e.g. x16) card to be installed physically  In teater bandwidth (e.g. x16) card to be installed physically  In teater bandwidth (e.g. x16) card to be installed physically			
PCI Connectors (5.0V)	Slot 6: PCI 32bit/33MHz Full-height, Full-length (with extende	er)			
Supported Drive Interfaces	SATA  Integrated 10-channel SATA interface (2@ 8@3Gb/s). Supports RAID 0, 1, 5, 10 and Factory integrated RAID is Microsoft Window				
	Serial Attached SCSI	Requires Optional PCIe card			
	<ul> <li>RAID 1 configuration - mirror</li> <li>RAID 5 parity striping (support</li> <li>RAID 10 striped and mirrored</li> <li>*HW RAID functionality not support</li> <li>Hat Operating system instead.</li> </ul>				
Integrated Graphics	No				
Network Controller	<ul> <li>Data rates supported 10/100</li> <li>Compliance IEEE 802.3, 802</li> <li>Bus architecture PCle 1.0a</li> <li>Data path width X1</li> <li>Data path speed 2.5Gbit per</li> <li>Data transfer mode Bus-mast</li> <li>Power requirement 1.0 watts</li> <li>Boot ROM support Yes</li> <li>Network transfer rate 10BASE</li> <li>10BASE-T (full-duplex) 20 Mt</li> <li>100BASE-TX (half-duplex) 10</li> <li>100BASE-TX (full-duplex) 200</li> <li>1000BASE-T (full-duplex) 200</li> </ul>	eive buffer and 8KB transmit buffer 0/1000 Mb/s 2.3AB and 802.3u compliant, 802.3x flow control  sec per direction transfer rate er DMA @ +3.3V AUX supply E-T (half-duplex) 10 Mb/s p/s 0 Mb/s 0 Mb/s 0 Mb/s ness 32 and 64, Microsoft Windows XP Professional 32			



SATA Connectors	10 ports/connectors (6 ports may b	pe cabled to optional eSATA cable kits [2 ports per cable kit])			
IEEE 1394a or 1394b	1394a is integrated 1394b is optional with PCle card Cable from Front IO can be plugged into PCle Card. Not supported in Linux				
IEEE 1394 Connector(s)	Front	1 - 1394a			
	Rear	1 - 1394a			
	Internal	No			
USB Connector(s)	Front	1 - USB 2.0 2 - USB 3.0			
	Rear	4 - USB 2.0 2 - USB 3.0			
	Internal	6 - USB 2.0 (3x 2x5 headers)  Provides connection for optional HP Internal USB Port Kits and Media Card Reader			
HD Integrated Audio	Realtek ALC262				
Flash ROM	Yes				
CPU Fan Header	One for each CPU socket				
Chassis Fan Header	Rear System Chassis Fan Header Front System Chassis Fan Header				
CMOS Battery Holder – Lithium	Yes				
Integrated Trusted Platform Module	TPM 1.2, Infineon				
Power Supply Headers	Yes				
Power Switch, Power LED & Hard Drive LED Header	Yes (includes speaker and intrusion	sensor signals)			
Clear Password Jumper	Yes				
Serial Port	Optional				
Parallel Port	No				
Keyboard/Mouse	PS/2				



System Technical Specifications

Z620 Required Power Supply Info					
Power Supply		800W 90% Efficient, Custom PSU (Wide Ranging, Active PFC)			
Operating Voltage Range		90–269	9 VAC		
Rated Voltage Range		100–240 V	118 V		
Rated Line Frequency		50–60 Hz	400 Hz		
Operating Line Frequency Range		47–66 Hz	393–407 Hz		
Rated Input Current		9.7 A @ 100-240 V	9.7 A @ 400 V		
Heat Dissipation (Configuration and software depend	dent)	Typical = 1972 btu Maximum = 3139 bt			
Power Supply Fan		92x25 mm vo	riable speed		
ENERGY STAR Qualified (Configuration dependent)		Ye	s		
80 PLUS® Compliant		Yes, 90%	Efficient		
		The Z620 800W power supply efficie			
FEMP Standby Power Compliant@1 LAN disabled)(<2W in S5-Power C		Yes			
EuP Compliant@230V (<1 W in S	5-Power Off)	Yes			
CECP Compliant @ 220V (<4W in S3 - Suspend to RAM)		Yes; Configuration dependent			
Power Consumption in sleep mode ENERGY STAR) - Suspend to RAM ( Available PC) measured at 115V.		<15W			
Built-in Selft Test LED		Yes			
Surge Tolerant Full Ranging Power (withstands power surges up to 200		Yes			
Access Panel Solenoid Lock Header	Yes				
Access Panel Intrusion Sensor Header	Yes Integrated in Fror	nt User Interface (Power Switch, Power LE	ED, HDD LED, Speaker) Cable		
Multibay Header	No				
ntegrated Gigabit Ethernet	Integrated Intel 8	2579 and 82574 Controllers			
Wake on LAN	Yes				
ASF 1.0/2.0 (Alert Standard Format)	No				
ГРМ	Integrated TPM 1.2; Infineon				
Password Clear Header	Yes				
AUX IN (audio)	No				
Clear CMOS Button	Yes	Yes			
Memory Fan Header	CPU0 Memory Fo	an Header; CPU1 Memory Fan Header			

System Configuration



Example Configuration	Processor Info	1x Intel Xeon	E5-2650 (Ei	ight-Core)			
#1	Memory Info	4x 2GB DDR3 1600 (UDIMM)					
(ENERGY STAR	Graphics Info	1x NVIDIA G	1x NVIDIA Quadro 600				
QUALIFIED)	Disks/Optical/Floppy	1x 250GB S	ATA 7200/1>	k 16X DVD-R0	OM SATA		
	Power Supply	800W 90% (	Custom PSU				
	Other	1x NVIDIA T	esla C2075				
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	111	I W	110	O W	11.	1 W
	Windows Busy Typ (S0)	287	7 W	270	5 W	286	5 W
	Windows Busy Max (S0)	396 W		390 W		398 W	
	Sleep (S3)	4.25 W	4.10 W	4.43 W	4.31 W	4.25 W	4.11 W
	Off (\$5)	1.81 W	1.62 W	2.07 W	1.89 W	1.79 W	1.61 W
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.2	3 W
Heat Dissipation**		115 VAC		230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	379 k	otu/hr	375 l	otu/hr	379 l	otu/hr
	Windows Busy Typ (S0)	979 l	otu/hr	942 l	otu/hr	976 l	otu/hr
	Windows Busy Max (S0)	1351	btu/hr	1331	btu/hr	1358	btu/hr
	Sleep (S3)	14.5 btu/hr	14.0 btu/hr	15.1 btu/hr	14.7 btu/hr	14.5 btu/hr	14.0 btu/hr
	Off (S5)	6.18 btu/hr	5.53 btu/hr	7.06 btu/hr	6.45 btu/hr	6.11 btu/hr	5.49 btu/hr
	Zero Power Mode (ErP)	0.85	otu/hr	1.54	btu/hr	0.78	btu/hr

Example Configuration #2 (ENERGY STAR QUALIFIED)	Processor Info Memory Info Graphics Info Disks/Optical/Floppy Power Supply	1x Intel Xeon E5-2643 (Four-Core) 4x 4GB DDR3 1600 (UDIMM) 1x NVIDIA NVS 300 2x 500GB SATA 7200/1x 16X DVD-ROM SATA 800W 90% Custom PSU					
	Other	- Custom F3U					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	66.	8 W	66.	3 W	66.	9 W
	Windows Busy Typ (S0)	170 W 169 W 171 W		1 W			
	Windows Busy Max (S0)	193 W		190 W		193 W	
	Sleep (S3)	4.43 W	4.31 W	4.62 W	4.51 W	4.43 W	4.33 W
	Off (\$5)	1.81 W	1.38 W	2.07 W	1.64 W	1.78 W	1.36 W
	Zero Power Mode (ErP)	0.24 W 0.45 W 0.23 W				3 W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	228 ا	otu/hr	226 k	otu/hr	228 l	otu/hr
	Windows Busy Typ (S0)	580 l	otu/hr	577 k	otu/hr	583 l	otu/hr
	Windows Busy Max (S0)	659 1	otu/hr	648 k	otu/hr	659 l	otu/hr
	Sleep (S3)	15.1 btu/hr	14.7 btu/hr	15.8 btu/hr	15.4 btu/hr	15.1 btu/hr	14.8 btu/hr
	Off (\$5)	6.18 btu/hr	4.71 btu/hr	7.06 btu/hr	5.60 btu/hr	6.07 btu/hr	4.64 btu/hr
	Zero Power Mode (ErP)	0.82	btu/hr	1.54	otu/hr	0.78	btu/hr



Example Configuration	Processor Info	2x Intel Xeon E5-2690 (Eight-Core)					
#3	Memory Info	8x 8GB DDR3 1600 (RDIMM)					
(ENERGY STAR	Graphics Info	1x NVIDIA Quadro 2000					
QUALIFIED)	Disks/Optical/Floppy	2x 250GB S	ATA 7200/1>	k 16X DVD+-	-RW SuperMi	ılti SATA	
	Power Supply	800W 90% (	Custom PSU				
	Other	-					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	12	I W	120	O W	122	2 W
	Windows Busy Typ (S0)	506 W 494 W 518 W		3 W			
	Windows Busy Max (S0)	54	l W	53	1 W	544	1 W
	Sleep (S3)	7.75 W	7.57 W	7.84 W	7.67 W	7.82 W	7.62 W
	Off (\$5)	1.97 W	1.57 W	2.18 W	1.82 W	1.96 W	1.55 W
	Zero Power Mode (ErP)	0.2	4 W	0.4	4 W	0.23	3 W
Heat Dissipation**		115 VAC		230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	413 l	otu/hr	409 l	otu/hr	416 k	otu/hr
	Windows Busy Typ (S0)	1727	btu/hr	1686	btu/hr	1767	btu/hr
	Windows Busy Max (S0)	1846	btu/hr	1812	btu/hr	1856	btu/hr
	Sleep (S3)	26.4 btu/hr	25.8 btu/hr	26.8 btu/hr	26.2 btu/hr	26.7 btu/hr	26.0 btu/hr
	Off (\$5)	6.72 btu/hr	5.36 btu/hr	7.44 btu/hr	6.21 btu/hr	6.69 btu/hr	5.29 btu/hr
	Zero Power Mode (ErP)	0.82	otu/hr	1.50	btu/hr	0.78	btu/hr

Example Configuration	Processor Info	2x Intel Xeon	E5-2620 (Si	ix-Core)				
#4	Memory Info	12x 4GB DE	R3 1600 (UI	DIMM)				
	Graphics Info	2x NVIDIA G	Quadro 5000	)				
	Disks/Optical/Floppy	4x 600GB S	4x 600GB SAS 15K/1x 16X DVD+-RW SuperMulti SATA					
	Power Supply	800W 90% Custom PSU						
	Other	LSI 9212 SA	S Card					
Energy Consumption		115	VAC	230	VAC	100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	210	5 W	213	3 W	217	7 W	
	Windows Busy Typ (S0)	525	525 W 48		5 W	512	2 W	
	Windows Busy Max (S0)	644	644 W		631 W		647 W	
	Sleep (S3)	9.27 W	8.81 W	9.36 W	8.91 W	9.31 W	8.89 W	
	Off (S5)	1.85 W	1.43 W	2.12 W	1.68 W	1.83 W	1.41 W	
	Zero Power Mode (ErP)	0.2	5 W	0.4	5 W	0.2	3 W	
Heat Dissipation**		115 VAC		230 VAC		100 VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	737 l	otu/hr	727	otu/hr	740 l	otu/hr	
	Windows Busy Typ (S0)	1791	btu/hr	1655	btu/hr	1747	btu/hr	
	Windows Busy Max (S0)	2197	btu/hr	2153	btu/hr	2208	btu/hr	
	Sleep (S3)	31.6 btu/hr	30.1 btu/hr	31.9 btu/hr	30.4 btu/hr	31.8 btu/hr	30.3 btu/hr	
	Off (S5)	6.31 btu/hr	4.88 btu/hr	7.23 btu/hr	5.73 btu/hr	6.24 btu/hr	4.81 btu/hr	
	Zero Power Mode (ErP)	0.85	btu/hr	1.54	btu/hr	0.78	btu/hr	



Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration (Entry level)	Processor Info	Single Intel Xeon E5-2640 2.50 GHz		
	Memory Info	4 - 2 GB DDR3 1333 MHz UDIMM		
	Graphics Info	NVIDIA Q400		
	Disks/Optical/Floppy	Single 1 TB 7200 RPM SATA DVD ROM		

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.3	16
	Hard drive Operating (random reads)	3.9	22
	DVD-ROM Operating (sequential reads)	5.1	39

System Configuration	Processor Info	Dual Xeon E5-2690 2.90 GHz
(High-end)	Memory Info	12 - 4GB DDR3 1600 MHz UDIMM
	Graphics Info	NVIDIA Q4000
	Disks/Optical/Floppy	Dual 600 GB 15K RPM SAS 3.5"
		DVD ROM

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	4.4	29
	Hard drive Operating (random reads)	4.8	32
	DVD-ROM Operating (sequential reads)	5.1	36

Environmental Requirements	Temperature	Operating: 5°C to 35°C (40°F to 95°F) Non-operating: -40°C to 60°C (-40°F to 140°F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,048 m (10,000 ft) Non-operating: 9,144 m (30,000 ft)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events.  Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524m (5,000 ft) altitude, maximum operating temperature is derated by 1°C (1.8°F) per 305m (1,000 ft) elevation increase

Physical Security an	d Serviceability
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, no carrier or rails required
Hard Drives	Tool-less
	Integrated blind-mate drive carriers
	Optional 5.25" external bay carriers
Expansion Cards	Tool-less
Processor Socket	1st socket on main system board. 2nd socket on optional 2nd CPU/Memory Module.
Green User Touch Points	Yes, on primary serviceable components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less 2nd CPU/Memory Module: Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes, at POST screen on reboot.
Restore CD/DVD Set	Yes, restores the computer to its original factory shipping image - Can be obtained via HP Support.



system rechnical spe	Cinculons
Dual Function Front Power Switch	Yes, also acts as a reset switch when held for 4 seconds.
Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system
Universal Chassis Clamp Lock Support	No
Solenoid Lock and Hood Sensor	Access Panel Solenoid Lock: Yes (optional). Activated remotely to prevent system entry. Access Panel Intrusion Sensor: Yes (optional).
Rear Port Control Cover	No
Removable Media Write/Boot Control	Yes, user can prevent the workstation from writing to or booting from removable media.
Power-On Password	Yes, prevents an unauthorized person from booting up the computer.
Setup Password	Yes, prevents an unauthorized person from changing the system configuration.
3.3V Aux Power LED on System PCA	No
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	CPU heatsink removal requires a T-15 Torx or flat blade screwdriver. CPU removal is tool-less.
Power Supply Diagnostic LED	Yes
Front Power Button	Yes
Rear Power Button	Yes
Front Power LED	Yes, blue (normal), red (fault)
Front Hard Drive Activity LED	Yes, green
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS
Cooling Solutions	Air cooled forced convection
Power Supply Fans	1 - 92mm
CPU Heatsink Fan	1st CPU: 1 - 92mm Optional 2nd CPU: 1 - 92mm
Memory Heatsink Fan	System Board Memory: rear bank: 1 - 60mm, front bank: 1 - 40mm Optional 2nd CPU/Memory Module: rear bank: 1 - 80mm.
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:
	<ul> <li>Run diagnostics</li> <li>View the hardware configuration of the system</li> </ul>
	Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly



	resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision diagnostics helps provide higher system availability. Typical uses of the Vision Diagnostics are:  • Testing and diagnosing apparent hardware failures • Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance • Sending configuration information to another location for more in-depth analysis
Access Panel Key Lock	Yes, prevents removal of the access panel and all internal components including devices installed in the external 5.25" bays.
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).
	<ul> <li>Allows the system to wake from a low power mode</li> <li>Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system</li> </ul>
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2
Integrated Chassis Handles	Yes
Power Supply	Tool-less. Includes integrated handle.
PCI Card Retention	Yes, tool-less Rear (all) Middle (full-height cards) Front (full-length cards with extender)
Flash ROM	SPI ROM
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes
HP ProtectTools Security Manager	Yes - Not supported on Linux

BIOS		
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4	
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0	
BBS	BIOS Boot Specification v1.01	
	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows fully compliant with the Distributed Management Task Force (DMTF) Common Information Modand WBEM specifications.	



BIOS Power On Users can define a specific date and time for the system to power on  ROM Based Computer Setup Utility (F10)  Recovers system BIOS in corrupted Flash ROM Flash Recovery with Video  Replicated Setup  Soves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS  System Management BIOS 2.7 for system management information  Boot Control  Disables the ability to boot from removable media on supported devices  Memory Change Alert  Thermal Alert  Monitors the temperature state within the chassis. Three modes:  • NORMAL - normal temperature ranges.  • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash  ACPI (Advanced  Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep state).  Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag  Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location Shutdown  Instantly Available PC  (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PKE 2.1) (Remote Boot from Server)  Allows a new or existing system to boot over the network and download software, including the operating system	, ,						
Review and customize system configuration settings controlled by the BIOS System/Emergery ROM Flosh Recovery with Video Replicated Setup Replicated Setup System/Emergery ROM Flosh Recovery with Video Replicated Setup System Management BIOS 2.7 for system management information Disables the ability to boot from removable media on supported devices Memory Change Alert Thermal Alert Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  NORMAL - normal temperature ranges.  NORMAL - normal temperatures and educated. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - accessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - accessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.  SHUTDOWN - accessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Allows the system to enter and resume from low power modes (sleep states).  Configuration and Power Management Interface) Allows the system to enter and resume from low power modes (sleep states).  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Allows for very low power consumption with quick resume time  System bacar revisi	BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot					
Setup Utility (F10) System/Emergency ROM Flosh Recovery with Video Replicated Setup Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS System Management BIOS 2.7 for system management information Boot Control Disables the ability to boot from removable media on supported devices Memory Change Alert Thermal Alert  Monitors the temperature state within the chossis. Three modes:  • NORMAL + normal temperature ranges. • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. • SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  ACPI (Advanced Configuration and Power Management Interface)  ACPI (Advanced Configuration and Power Management Interface)  ACPI (Advanced Configuration of the system to enter and resume from low power modes (sleep states).  Cownership Tag  Remote Wakeup/Remote Shutdown  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen  Shutdown  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen  Allows for very low power consumption with quick resume time  System administrators can power on, restart, and power off a client computer from a remote location  Shutdown  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  RoM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Varsion is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Reports the system BIOS revision level of the system board  level  System board revision  Allows management SW to re	BIOS Power On	Users can define a specific date and time for the system to power on					
Flosh Recovery with Video Replicated Setup Soves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS System Management BIOS 2.7 for system management information Boot Control Disables the ability to boot from removable media on supported devices  Memory Change Alert Thermal Alert  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges. AletRTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown. SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.  Remote ROM Flash ACPI (Advanced Configuration and Power Management Interface) Allows the system to enter and resume from low power modes (sleep states). Configuration and Power Management Interface Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag A user-defined string stored in non-valatile memory that is displayed in the BIOS splash screen  Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location Shutdown Instantly Available PC (Suspend to RAM - ACP) sleep state S)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  RoM revision levels RoM revision levels Romade System board revision System board revision Allows a new or existing system to boot over the network and download software, including the industry standard interface (SMBIOS) so that management SW applications can use and report this information.  Allows management SW to read revision level to The BIOS splash sort and advance to the system board revision level is		Review and customize system configuration settings controlled by the BIOS					
replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).  SMBIOS  System Management BIOS 2.7 for system management information  Disables the ability to boot from removable media on supported devices  Memory Change Alert  Thermal Alert  Monitors the temperature state within the chassis. Three modes:  NORMAL - normal temperature ranges.  NORMAL - normal temperat		Recovers system BIOS in corrupted Flash ROM					
Boot Control   Disables the ability to boot from removable media on supported devices	Replicated Setup	replicate these settings on machines being deployed without entering Computer Configuration Utility					
Alerts management console if memory is removed or changed	SMBIOS	System Management BIOS 2.7 for system management information					
Monitors the temperature state within the chassis. Three modes:   NORMAL - normal temperature ranges.   ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.   SHUTDOWN - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.   SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs.   Remote ROM Flash   Provides secure, fail-safe ROM image management from a central network console     ACPI (Advanced Configuration and Power   Management Interface)   Allows the system to enter and resume from low power modes (sleep states).   Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.   Supports ACPI 2.0 for full compatibility with 64-bit operating systems.   Ownership Tag	Boot Control	Disables the ability to boot from removable media on supported devices					
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ACPI (Advanced Configuration and Power Management Interface)  Allows the system to enter and resume from low power modes (sleep states). Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen  Remote Wakeup/Remote Shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Level  Allows an anagement SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified  Allows management SW apelications can use and revision level is digitally encoded into the HW and cannot be modified  Allows for very low power consumption with quick resume time  Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision  Level  Start-up Diagnostics  (Power-on Self-Test)  Auto Setup when new hardware installed		<ul> <li>ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.</li> <li>SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer</li> </ul>					
Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.  Supports ACPI 2.0 for full compatibility with 64-bit operating systems.  Ownership Tag  A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen  Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location shutdown  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level is digitally encoded into the HW and cannot be modified  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed	Remote ROM Flash	note ROM Flash Provides secure, fail-safe ROM image management from a central network console					
Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location  Instantly Available PC (Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level is digitally encoded into the HW and cannot be modified  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed	Configuration and Power	Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.					
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)   Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)   ROM revision levels   Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.	Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen					
(Suspend to RAM - ACPI sleep state S3)  Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is availabed through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level is digitally encoded into the HW and cannot be modified  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Allows a new or existing system to boot over the network and download software, including the operating system to boot over the network and download software, including the operating system operating system to boot over the network and download software, including the operating system operating system to boot over the network and download software, including the operating system operating system to boot over the network and download software, including the operating system operating system operating system to boot over the network and download software, including the operating system operating system operating system operating system to boot over the network and download software, including the operating system operating syst	Remote Wakeup/Remote	System administrators can power on, restart, and power off a client computer from a remote location					
Installation via F12 (PXE 2.1) (Remote Boot from Server)  ROM revision levels  Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is availabed through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level  Allows management SW to read revision level of the system board Revision level is digitally encoded into the HW and cannot be modified  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Assesses system automatically detects the addition of new hardware	(Suspend to RAM - ACPI	Allows for very low power consumption with quick resume time					
through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.  System board revision level of the system board Revision level is digitally encoded into the HW and cannot be modified  Start-up Diagnostics (Power-on Self-Test)  Auto Setup when new hardware installed  Assesses system dealth at boot time with selectable levels of testing  System automatically detects the addition of new hardware	Installation via F12 (PXE 2.1) (Remote Boot from						
Revision level is digitally encoded into the HW and cannot be modified   Start-up Diagnostics (Power-on Self-Test)	ROM revision levels						
(Power-on Self-Test)  Auto Setup when new hardware installed  System automatically detects the addition of new hardware	·	,					
hardware installed		Assesses system health at boot time with selectable levels of testing					
Keyboard-less Operation The system can be booted without a keyboard		System automatically detects the addition of new hardware					
	Keyboard-less Operation	The system can be booted without a keyboard					



### System Technical Specifications

Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings				
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memor				
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually				
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics				
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED				
Industry Standard Specification Support					
Industry Standard	Revision Supported by the BIOS				
ACPI	Advanced Configuration and Power Management Interface, Version 2.0				
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b				
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0				
EDD	<ul> <li>Enhanced Disk Drive Specification Version 1.1</li> <li>BIOS Enhanced Disk Drive Specification Version 3.0</li> </ul>				
Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0					
PCI	<ul> <li>PCI Local Bus Specification, Revision 2.3</li> <li>PCI Power Management Specification, Revision 1.1</li> <li>PCI Firmware Specification, Revision 3.0, Draft 0.7</li> </ul>				
PCI Express	PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0				
PMM	POST Memory Manager Specification, Version 1.01				
SATA	<ul> <li>Serial ATA Specification, Revision 1.0a</li> <li>Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5</li> <li>Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0</li> </ul>				
SPD PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2					
TPM Trusted Computing Group TPM Specification Version 1.2					
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1				
USB	Universal Serial Bus Revision 1.1 Specification  Universal Serial Bus Revision 2.0 Specification  Universal Serial Bus Revision 3.0 Specification				
SMBIOS	System Management BIOS Reference Specification, Version 2.7				
31410103	Joyston Management BIOS Reference Specification, Version 2.7				

### Social and Environmental Responsibility

## Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- ENERGY STAR (Configuration dependent, Microsoft Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- IT ECO declaration
- Japan PC Green label\*

\* This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'



### System Technical Specifications

### Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4,000ppm by weight.

Battery size: CR2032 (coin cell)

Battery type: Lithium

### Restricted Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen\_specifications.html):

- Asbestos
- Batteries Mercury
- Batteries Cadmium
- Batteries Lead (non-rechargeable)
- Batteries Non-rechargeable Alkaline and Carbon-Zinc Batteries
- Batteries Classification as "Not Restricted" for Transport
- Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE)
- Brominated Flame Retardants (all BFRs in external case plastic parts)
- Cadmium and its compounds
- Certain Azo Colorants
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Formaldehyde emissions
- Hexavalent Chromium and its compounds in metallic applications
- Hexavalent Chromium and its compounds in non-metallic applications
- Lead and its compounds
- Lead in paint
- Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords
- Mercury and its compounds
- Nickel on external surfaces
- Ozone Depleting Substances (ODS)
- Polycyclic Aromatic Hydrocarbons (PAH)
- Perfluorooctane sulfonates (PFOS) in parts
- Perfluorooctane sulfonates (PFOS) in preparations
- Polychlorinated Biphenyls (PCBs) and Polychlorinated Terphenyls (PCTs)
- Polychlorinated Naphthalenes
- Polyvinyl Chloride (PVC) in external case plastic parts
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)



BFR/PVC-Free Statement	Configurations of the HP Z620 Workstation where SAS 3 ½" HDDs, Intel SAS Controller Module, Creative Recon3D PCle Audio Card, Broadcom 5761 Gigabit PCle NIC, or LSI 9260-8i SAS 6Gb/s ROC RAID Card are not selected are brominated flame retardant and polyvinyl chloride free (BFR/PVC-free), meeting the evolving definition of "BFR/PVC-free" as set forth in the iNEMI Position Statement on the Definition of Low-Halogen Electronics (BFR/CFR/PVC-Free).  http://thor.inemi.org/webdownload/projects/ese/HFR-Free/Low-Halogen Def.pdf					
End-of-Life Management	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.					
and Recycling	o recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales ffice. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.					
Hewlett-Packard	For more information about HP's commitment to the environment:					
Corporate Environmental						
Information	Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html					
	Eco-label certifications:					
	http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html					
	ISO 14001 certificates:					
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html					
Additional Information	This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -					
Additional information	2002/95/EC.					
	This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE)					
	Directive - 2002/96/EC.					
	Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and					
	ISO1043.					
	This product contains 0% recycled materials (by wt.)					
	This product is >90% recycle-able when properly disposed of at end of life.					
Packaging	HP Workstation product packaging meets the following (refer to the HP General Specification for the Environment (http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf)					
	Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment (see link above).					
	Does not contain ozone-depleting substances (ODS).					
	Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of					
	100 ppm sum total for all heavy metals listed.					
	Maximize the use of post-consumer recycled content materials in packaging materials.					
	All packaging material is recyclable.					
	All packaging material is designed for ease of disassembly.					
	Reduce size and weight of packages to improve transportation fuel efficiency.					
	Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.					
Packaging Materials						
Internal	LDPE Foam and Bag: 0.5 kg					
External	Cardboard carton and insert: 1.5 kg					

Manageability	geability				
Industry Standard	This product meets the following industry standard specifications for manageability functionality:				
Specifications					
·	DASH 1.1 required functionalities via Intel LAN on motherboard				
Intel Active Management	Intel Active Management Technology (AMT) 7.0				
Technology (AMT)					
	An advanced set of remote management features and functionality providing IT administrators the latest				



### System Technical Specifications

and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 7.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions)
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back

### Intel® vPro™ Technology

The HP Z620 Workstation supports Intel vPro technology when configured as outlined below:

- Intel Xeon processor E5-1600 product family or E5-2600 product family featuring Intel vPro Technology
- Intel C602 chipset
- Intel 82579LM GbE LAN

### Remote Manageability Software Solutions

The HP Z620 Workstation is supported on the following remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager
- HP Client Automation Enterprise

For questions or support for manageability needs, please visit http://www.hp.com/go/easydeploy

System Software Manager For questions or support for SSM, please visit: http://www.hp.com/go/ssm

### Service, Support, and Warranty

On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers onsite, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack



	Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location.			
Product Change Notification	<ul> <li>Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.</li> <li>PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.</li> <li>Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.</li> </ul>			



### Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering
	A2A06AV	Intel Xeon E5-2620 2 15M 1333 6C 1 CPU
	A2A19AV	Intel Xeon E5-2620 2 15M 1333 6C 2 CPU
	A2A09AV	Intel Xeon E5-2643 3.3 10M 1600 4C 1 CPU
	A2A22AV	Intel Xeon E5-2643 3.3 10M 1600 4C 2 CPU
Hard Drives	Product #	Offering
	QG001AV	500GB 7200 RPM SATA 1st HDD
	QG011AV	500GB 7200 RPM SATA 2nd HDD
	QG021AV	500GB 7200 RPM SATA 3rd HDD
	QG031AV	500GB 7200 RPM SATA 4th HDD
	QG002AV	1TB 7200 RPM SATA 1st HDD
	QG012AV	1TB 7200 RPM SATA 2nd HDD
	QG022AV	1TB 7200 RPM SATA 3rd HDD
	QG032AV	1TB 7200 RPM SATA 4th HDD
Graphics	Product #	Offering
	A7U49AV	NVIDIA NVS 310 512MB GFX
	A7U50AV	NVIDIA NVS 310 512MB 2nd GFX
	A7U51AV	NVIDIA NVS 310 512MB 3rd GFX
	A7U52AV	NVIDIA NVS 310 512MB 4th GFX
Memory	Product #	Offering
		Any configuration with 2GB DDR3-1600 ECC Unbuffered DIMMs
		Any configuration with 4GB DDR3-1600 ECC Unbuffered DIMMs
		Any configuration with 4GB DDR3-1600 ECC Registered DIMMs
		Any configuration with 8GB DDR3-1600 ECC Registered DIMMs
Optical and Removable	Product #	Offering
Storage	QG049AV	16X SuperMulti DVDRW SATA 1st ODD
	QG053AV	16x SuperMulti DVDRW SATA 2nd ODD



Stable & Consistent Offerings

Input Devices	Product #	Offering
	A8Z53AV	HP USB Keyboard (available June 2012)
	A8Z55AV	HP USB Optical Mouse (available June 2012)
Operating Systems	Product #	Offering
	LJ454AV	Windows 7 Professional 64-bit OS



### Technical Specifications - Processors

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П	ro	CE	355	ന	rs

Intel® Xeon® Processor E5-2603 4C 1.80GHz Intel® Xeon® Processor E5-2609 4C 2.40GHz Intel® Xeon® Processor E5-2620 6C 2.00GHz Intel® Xeon® Processor E5-2630 6C 2.30GHz Intel® Xeon® Processor E5-2640 6C 2.50GHz Intel® Xeon® Processor E5-2643 4C 3.30GHz Intel® Xeon® Processor E5-2650 8C 2.00GHz Intel® Xeon® Processor E5-2660 8C 2.20GHz Intel® Xeon® Processor E5-2665 8C 2.40GHz Intel® Xeon® Processor E5-2667 6C 2.90GHz Intel® Xeon® Processor E5-2670 8C 2.60GHz Intel® Xeon® Processor E5-2680 8C 2.70GHz Intel® Xeon® Processor E5-2690 8C 2.90GHz Intel® Xeon® Processor E5-1660 6C 3.30GHz Intel® Xeon® Processor E5-1650 6C 3.20GHz Intel® Xeon® Processor E5-1620 4C 3.60GHz Intel® Xeon® Processor E5-1607 4C 3.00GHz Intel® Xeon® Processor E5-1603 4C 2.80GHz

### **Processor Note**

For detailed processor specifications, please refer to the Overview section at the beginning of this document.

Z620 Xeon E5-2603 4C 1.80 10MB 1066 CPU2	A6S72AA
Z620 Xeon E5-2609 4C 2.40 10MB 1066 CPU2	A6S73AA
Z620 Xeon E5-2620 6C 2.00 15MB 1333 CPU2	A6S74AA
Z620 Xeon E5-2630 6C 2.30 15MB 1333 CPU2	A6S75AA
Z620 Xeon E5-2640 6C 2.50 15MB 1333 CPU2	A6S76AA
Z620 Xeon E5-2643 4C 3.30 10MB 1600 CPU2	A6S77AA
Z620 Xeon E5-2650 8C 2.00 20MB 1600 CPU2	A6S78AA
Z620 Xeon E5-2660 8C 2.20 20MB 1600 CPU2	A6S79AA
Z620 Xeon E5-2665 8C 2.40 20MB 1600 CPU2	A6S80AA
Z620 Xeon E5-2667 6C 2.90 15MB 1600 CPU2	A6S81AA
Z620 Xeon E5-2670 8C 2.60 20MB 1600 CPU2	A6S82AA
Z620 Xeon E5-2680 8C 2.70 20MB 1600 CPU2	A6S83AA
Z620 Xeon E5-2690 8C 2.90 20MB 1600 CPU2	A6S84AA



Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP 6Gb/s 3.5" HDD Workstations

600GB SAS 15K rpm

600GB Capacity Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.17 cm

SAS Interface Synchronous Transfer 6.0 Gb/s Rate (Maximum)

Buffer

0.2 ms Seek Time (typical reads, Single Track includes controller Average 3.4 ms overhead, including Full Stroke 6.6 ms settling)

16 MB

**Rotational Speed** 15,000 rpm

1,172,123,568 - 512 byte blocks Logical Blocks

**Operating Temperature** 50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s 3.5" HDD

Capacity 450GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.17 cm

Interface SAS Synchronous Transfer 6Gb/s Rate (Maximum)

Buffer 16MB

Seek Time (typical reads, Single Track 0.2 ms includes controller Average 3.4 ms overhead, including Full Stroke 6.6 ms settling)

15,000 rpm **Rotational Speed** 

50° to 95° F (10° to 35° C) Operating Temperature

300GB SAS 15K rpm 6Gb/s 3.5" HDD

Capacity 300GB Height 1 in; 2.54 cm

Width 3.5 in; 8.9 cm Media Diameter 4 in; 10.17 cm Physical Size

SAS Interface Synchronous Transfer 6Gb/s Rate (Maximum)

Buffer 16MB

0.2 ms Seek Time (typical reads, Single Track includes controller 3.4 ms Average overhead, including Full Stroke 6.6 ms settling)



Technical Specifications - Hard Drives

Rotational Speed 15,000 rpm

50° to 95° F (10° to 35° C) Operating Temperature

HP 300GB SAS 10K SFF

**HDD** 

Capacity 300GB

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm 2.75 in; 6.99 cm

Physical Size

SAS 6Gb/s Interface Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical reads, Single Track 0.4 ms (max) includes controller Average 3.6 ms overhead, including Full Stroke 7.3 ms settling)

**Rotational Speed** 10,000 rpm 585,937,500 Logical Blocks

Operating Temperature 41° to 131° F (5° to 55° C)

HP 600GB SAS 10K SFF

HDD

Capacity 600GB

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

2.75 in; 6.99 cm Physical Size

Interface SAS 6Gb/s Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Cache multi-segmentable cache buffer

Seek Time (typical reads, Single Track 0.4 ms (max) includes controller Average 3.6 ms overhead, including Full Stroke 7.3 ms settling)

10,000 rpm **Rotational Speed** Logical Blocks 1,172,123,568

41° to 131° F (5° to 55° C) Operating Temperature

SATA (Serial ATA) Hard

Drives for HP Workstations

3.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 3.0TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled



Not Specified

## **QuickSpecs**

Technical Specifications - Hard Drives

Synchronous Transfer Up to 6.0 Gb/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, Single Track 0.6 ms includes controller Average 11 ms overhead, including

Full Stroke

settling)

**Rotational Speed** 7,200 rpm

41° to 140° F (5° to 60° C) Operating Temperature

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

2.0TB Capacity

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600 MB/s

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Rate (Maximum)

64MB Buffer

1.0 ms Seek Time (typical reads, Single Track includes controller Average 11 ms overhead, including Full Stroke 18 ms

settling)

7,200 rpm **Rotational Speed** Logical Blocks 3,907,029,168

41° to 131° F (5° to 55° C) Operating Temperature

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 1 Terabyte (1000 GB)

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm 4.0 in; 10.17 cm Physical Size

Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Interface

Buffer 32MB

Seek Time (typical reads, Single Track 2 ms includes controller Average 11 ms overhead, including Full Stroke 21 ms

settling)

**Rotational Speed** 7,200 rpm 1,953,525,168 Logical Blocks

Operating Temperature

41° to 131° F (5° to 55° C)

500GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 500GB Height 1 in; 2.5 cm



Technical Specifications - Hard Drives

Width	Media Diameter	3.5 in; 8.9 cm	
	Physical Size	4 in; 10.17 cm	
Interface	Serial ATA (6.0Gb/s)	, NCQ enabled	

Up to 600MB/s

Synchronous Transfer Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads, Single Track 2 ms includes controller 11 ms Average overhead, including **Full Stroke** 21 ms settling)

7,200 rpm Rotational Speed Logical Blocks 976,773,168

41° to 131° F (5° to 55° C) **Operating Temperature** 

250GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity 250 GB Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

4.0 in; 10.17 cm Physical Size

Interface Serial ATA (6.0Gb/s), NCQ enabled Up to 600MB/s

Synchronous Transfer

Rate (Maximum)

Buffer 8 MB

2 ms Seek Time (typical reads, Single Track includes controller 11 ms Average overhead, including Full Stroke 21 ms settling)

7,200 rpm Rotational Speed Logical Blocks 488,397,168

41° to 131° F (5° to 55° C) **Operating Temperature** 



Technical Specifications - Hard Drives

HP Solid State Drives for HP 160GB SATA SSD Capacity

Workstations

160GB

Width Media Diameter NaN in; NaN cm

Physical Size

2.5 in; 6.36 cm

SATA Interface Synchronous Transfer 3Gb/s

Rate (Maximum)

32° to 158° F (0° to 70° C) **Operating Temperature** 

HP 300GB SATA SSD Capacity 300GB

> Width Physical Size 2.5 in; 6.36 cm

Interface **SATA** Synchronous Transfer 3Gb/s

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)



#### Technical Specifications - Hard Drive Controllers

LSI 9212 4-Port SAS 6Gb/s RAID Card PCI Bus 8-lane, 5GT/s PCI Express 2.0

PCI Modes

RAID Levels

Bus Master DMA

RAID 0, 1, 1E and 10

PCI Data Burst Transfer Half Duplex, x4 PCIe 2000 MB/s
Rate Full Duplex, x8 PCIe 4000 MB/s

SAS Bandwidth Half Duplex Single lane - 600 MB/s

Wide Port (2 lanes) - 1200 MB/s Wide Port (4 lanes) - 2400 MB/s Single SAS Lane - 1200 MB/s

Full Duplex Single SAS Lane - 1200 MB/s

Wide Port (2 lanes) -2400 MB/s Wide Port (4 lanes) - 4800 MB/s

PCI Card Type3.3V Add-in cardPCI Voltage $12 V \pm 10\%$ PCI Power<13.5 Watts

Bracket Full height and Low-profile

Certification Level PCI-Express 2.0
IO Bus 1x4 6Gb/s SAS ports

SAS Processor LSISAS2004 Internal Connectors Four x1 SATA

External Connectors None Maximum Number of 256

SCSI Devices

LED Indicators Internal

Activity/Fault per x4 port - Heartbeat

LSI MegaRAID® 9260-8i PCI Bus SAS 6Gb/s ROC RAID PCI Mod Card and iBBU08 Battery Backup Unit RAID Le

PCI Bus PCI-Express (Gen2) V2.0 x8 lanes

PCI Modes Bus Master DMA RAID Levels RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Data Burst Transfer

Rate

Up to 4GB/s

PCI Card Type

Low profile, single PCIe slot design with full height bracket.

The optional iBBU08 Battery Backup unit mounts on the controller card and

the assembly remains within a single PCle slot width.

PCI Voltage +3.3V Add-in Card

PCI Power 12.5 Watts
Certification Level PCI-Express 2.0

IO Bus Eight 3 Gb/s and 6Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4

External Connectors None Maximum Number of 32.

SCSI Devices NOTE: HP Workstations do not support this many internal drives.



Technical Specifications - Hard Drive Controllers

**LED Indicators** 

Connector LEDs indicate whether the internal connector is active for ports 0- 3 and 4-7



#### Technical Specifications - Graphics

AMD FirePro 2270 512MB Graphics Card Form Factor Low Profile, Half Length, 2.3" x 6.6"

AMD FirePro™ 2270 Professional Graphics **Graphics Controller** 

PCI Express™ x16 Generation 2.0 **Bus Type** 

Memory **512MB DDR3** 

Connectors DMS-59 connector to support breakout cables for dual DisplayPort, DVI and

VGA output.

DMS-59 to Dual DVI adapter included.

(Display Port and VGA adapters sold separately)

Maximum Resolution Digital 2560x1600 (DisplayPort)

Analog 1920x1200 (DVI 60 Hz/ VGA 75Hz)

RAMDAC 400 MHz DAC, 10-bit per channel **Display Output** Card supports up to two displays Supported Graphics APIs DirectX 11 and OpenGL 4.0

**Available Graphics** 

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

17W Maximum Power Consumption

NVIDIA NV\$ 300 512MB Form Factor **Graphics Card** 

2.7 inches (H) x 5.7 inches (L), Half-Height

**Graphics Controller** NVIDIA NVS 300 Graphics Board **Bus Type** PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 SDRAM unified graphics memory

Connectors DMS-59

Includes DMS-59 to Dual DVI-I adapter

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapter

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

Maximum Resolution DVI: two digital displays up to 1920 x 1200

> DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080

Image Quality Features

**Display Output** 

This card support up to two displays:

- $\bullet$  Drives DVI enabled digital displays at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking
- Drives DisplayPort enabled digital displays at resolutions up to 2560 imes 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)
- Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)



Technical Specifications - Graphics

Supported Graphics APIs OGL 3.3

DirectX 10.1

Available Graphics

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <18 Watts

NVIDIA NVS 310 512MB Form Factor

**Graphics Card** 

Low Profile:

2.713 inches in height  $\times$  6.150 inches in length

**Graphics Controller** 

NVIDIA NVS 310

Bus Type

PCI Express x16, 2.0 compliant

Memory

Size: 512MB DDR3

Clock: 875Mhz

Memory Bandwidth: 14GB/s

Connectors

2 x DisplayPort 1.2

Maximum Resolution

Up to 2560 x 1600 (digital display) per display.

Image Quality Features

See Display Output section.

The following video formats are supported:

- MPEG2

- MPEG4 Part 2 Advanced Simple Profile

H.264 SVC codec supportSupport for 3D Blu Ray

- VC1

- DivX version 3.11 and later

- MVC

A full range of video resolutions are supported including 1080p, 1080i, 720p, 480p and 480i. The NVS 310 GPU provides hardware acceleration for the computationally intensive parts of video processing, as well as provides improved video playback speeds via faster decode and transcode.

**Display Output** 

Up to 2 displays in the following configurations:

DisplayPort output:

- Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics
- ullet Supports 2 monitors up to resolution of 1920 imes 1200 at 60 Hz with



Technical Specifications - Graphics

reduced blanking using DisplayPort 1.2 multi stream topology technology.

#### DVI-D output:

- ullet Drives two digital display at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors

#### HDMI output:

 $\bullet~$  NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920  $\times$  1080P at 60 Hz using DisplayPort to HDMl cable adaptors

#### VGA display output:

ullet Drives two analog display at resolutions up to 1920 imes 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Shading Architecture Supported Graphics APIs Shader Model 5.0 DX11, OpenGL 4.1

Available Graphics Drivers Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

19.5 Watts

Note

The thermal solution used on this card is an active fan heatsink.

Technical Specifications - Graphics

NVIDIA Quadro NVS 450 Form Factor

512 MB PCle Graphics

Card

ATX Full Height, 1/2 length

Passive cooling

Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 (256MB per GPU)

**Connectors** Four DisplayPort;

Four DisplayPort to DVI-D adapters included.

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution DisplayPort connectors support ultra-high-resolution panels (up to 2560 x

1600)

NOTE: This card supports up to four displays

Supported Graphics APIs OpenGL 3.0

DirectX 10.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Microsoft Windows Vista (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <40 Watts

NVIDIA Quadro 410 512MB Graphics Form Factor

Low Profile:

2.713 inches  $\times$  5.7 inches, single slot

**Graphics Controller** 

NVIDIA Quadro 410

Bus Type

PCI Express x16, 3.0 compliant

Memory

Size: 512MB DDR3

Clock: 900MHz

Memory Bandwidth: 14GB/s

Connectors

One dual-link DVI-I connector

One DisplayPort connector

Maximum Resolution

Up to 2560 x 1600 (digital display) per display.

**RAMDAC** 

400 MHz integrated RAMDAC

Display Output

Maximum resolution over DisplayPort:  $2560 \times 1600 \times 32$  bpp at 60 Hz

(reduced blanking)

Maximum resolution over DVI port:  $2560 \times 1600 \times 32$  bpp at 60 Hz

(reduced blanking)

Maximum resolution over VGA (through DVI to VGA cable):  $2048 \times 1536$ 

imes 32 bpp at 85 Hz



Technical Specifications - Graphics

Shading Architecture Shader Model 5.0 Supported Graphics APIs DX11, OpenGL 4.2

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

NVIDIA Quadro 600 1GB Graphics Card Form Factor 2.731" H x 6.6" L

Single Slot

Small Form Factor

Graphics Controller NVIDIA Quadro 600 Graphics Card

Bus Type PCI Express 2.0 x16
Memory 1 GB GDDR3

128-bit

Connectors 1 DVI-I output, 1 DisplayPort output

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

**Shading Architecture** Shader Model 5.0

Supported Graphics APIs OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com/

Power Consumption 40 Watts



#### Technical Specifications - Graphics

AMD FirePro V3900 1GB Form Factor

**Graphics Card** 

Full height, half length (full-height bracket included)

AMD FirePro™ V3900 professional graphics **Graphics Controller** 

**Bus Type** PCI Express® x16, Generation 2.1

Memory 1GB DDR3 memory Connectors 1 DL DVI, 1 DP output

One DP to DVI adapter included

Maximum Resolution 2560x1600 per display (5120x1600 max. horizontal resolution)

**Display Output** 1 DisplayPort® 1.2 1 Dual-link DVI

Supported Graphics APIs

**Available Graphics** 

Drivers

OpenCL<sup>™</sup> 1.1, DirectX® 11 and OpenGL 4.2

Genuine Windows® 7 Professional (64-bit and 32-bit) Genuine Windows Vista® Business (64-bit and 32-bit) Microsoft® Windows XP® Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

<50W

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort<sup>™</sup> active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be

required. See www.amd.com/firepro for details.

AMD FirePro V4900 1GB Form Factor

**Graphics Card** 

**Graphics Controller** 

Full height (4.37 in), half length (6.61 in) AMD FirePro™ V4900 Professional Graphics

**Bus Type** PCI Express<sup>™</sup> x16, Generation 2.1

Memory 1GB GDDR5

Connectors 2 DisplayPort, 1 dual link DVI Output, One DP to DVI adapter included

Maximum Resolution Up to three digital displays at resolutions up to 2560 x 1600 @ 60Hz or up

to three analog displays, one at resolutions up to 2048 x 1536 @ 85Hz, plus two resolutions up to 1920 x 1200 @ 60Hz (165 MHz dot clock) Note: This card supports up to three displays with Windows 7, Vista or Linux, and

up to two displays on XP

**RAMDAC** 

Image Quality Features

Up to 3 independent outputs with ATI Eyefinity technology support (More information at: www.amd.com/us/products/technologies/eyefinity/). Full 30bit display pipeline. Advanced video capabilities, including high fidelity gamma, color correction and scaling. Dedicated hardware (UVD2) for H.264, VC-1, and MPEG2 decode

NOTE: The use of more than two displays on Linux requires support for



Technical Specifications - Graphics

xrandr 1.2 or greater in the X server.

Supported graphics APIs DirectX 11 and OpenGL 4.1.

OpenCL 1.2 DirectCompute 11

Available graphics drivers Genuine Windows 7 Professional (64-bit and 32-bit)

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or the latest HP qualified drivers are

available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Power Consumption

<75W

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be

required. See www.amd.com/firepro for details.

NVIDIA Quadro 2000 1GB Graphics Card

Form Factor 4.376" H x 7" L

Single Slot

**Graphics Controller** 

NVIDIA Quadro 2000 Graphics Card

Bus Type

PCI Express 2.0 x16

Memory

1 GB GDDR5

128-bit

Connectors

1 DVI-I output, 2 DisplayPort outputs
One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz) Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Image Quality Features

- Up to 16K x16K texture and render processing
- Transparent multisampling and super sampling
- 16x angle independent anisotropic filtering
- 128-bit floating point performance
- 32-bit per-component floating point texture filtering and blending
- Support for any combination of two connected displays
- DisplayPort 1.1a, HDMI 1.3a, and HDCP support
- NVIDIA® 3D Vision<sup>™</sup> technology, 3D DLP, Interleaved, and other 3D stereo format support
- Full OpenGL quad buffered stereo support
- Underscan/overscan compensation and hardware scaling



Technical Specifications - Graphics

NVIDIA® nView® multi-display technology

Shading Architecture

Shader Model 5.0 Supported Graphics APIs OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

**Available Graphics** 

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

62 Watts Power Consumption

AMD FirePro V5900 2GB Form Factor

**Graphics Card** 

Full-height, full length, single slot

AMD FirePro™ V5900 Professional Graphics **Graphics Controller** 

**Bus Type** PCI Express<sup>™</sup> x16, Generation 2.1

2GB GDDR5 Memory

Connectors 2 x Display Port 1.2

1 x Dual-link DVI

One DP to DVI adapter included with card

Maximum Resolution

2560 x 1600

**Display Output** 

Up to 3 simultaneous displays (using AMD Eyefinity with Windows 7 or Linux)

Shading Architecture

Shader Model 5.0

Supported Graphics APIs

DirectX 11 and OpenGL 4.1

**Available Graphics** 

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

**Power Consumption** 

< 75 W

Note

AMD Eyefinity technology can support multiple displays using a single enabled AMD FirePro<sup>™</sup> professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort<sup>™</sup> active or passive adapters to convert your monitor's native



Technical Specifications - Graphics

input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be

required. See www.amd.com/firepro for details.

AMD FirePro V7900 2GB Form Factor

**Graphics Card** 

Full height, full length, single slot

**Graphics Controller** AMD FirePro™ V7900 Professional Graphics

**Bus Type** PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5

4 x DisplayPort 1.2 Connectors

Two DP to DVI adapters included with card

Maximum Resolution 2560 x1600

**Display Output** Up to 4 simultaneous displays (using AMD Eyefinity with Windows 7 or Linux)

Shading Architecture Shader Model 5.0

Supported Graphics APIs DirectX 11 and OpenGL 4.1

**Available Graphics** Genuine Windows 7 Professional (64-bit and 32-bit)

**Drivers** Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

< 150W **Power Consumption** 

Note AMD Eyefinity technology can support multiple displays using a single

> enabled AMD FirePro™ professional graphics card; the number of supported displays varies by card model. Microsoft® Windows® 7, Windows Vista®, or Linux® is required in order to support more than 2 displays. Depending on the card model, native DisplayPort<sup>™</sup> connectors and/or certified DisplayPort<sup>™</sup> active or passive adapters to convert your monitor's native

input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be

required. See www.amd.com/firepro for details.

#### Technical Specifications - Graphics

**NVIDIA Quadro 4000** 2GB Graphics Card

Form Factor 4.376" H x 9.50" L

Single Slot

**Graphics Controller** NVIDIA Quadro 4000 Graphics Card

**Bus Type** PCI Express 2.0 x16 Memory 2 GB GDDR5

256-bit

Connectors 1 DVI-I output, 2 DisplayPort outputs;

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI (single- link or dual-

link) adapters available as accessories

(Optional stereo bracket available from 3rd party)

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

RAMDAC 400 MHz integrated RAMDAC

Image Quality Features

• Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

16x angle independent anisotropic filtering

128-bit floating point performance

32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo format support

Full OpenGL quad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

Shading Architecture

Supported Graphics APIs OpenGL 4.0

DirectX 11

Shader Model 5.0

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

**Available Graphics** 

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** 142 Watts



Technical Specifications - Graphics

NVIDIA Quadro 5000 2.5GB Graphics Card

Form Factor 4.376" H x 9.75" L

**Dual Slot** 

**Graphics Controller** NVIDIA Quadro 5000 Graphics Card

**Bus Type** PCI Express 2.0 x16 Memory 2.5 GB GDDR5

320-bit

Connectors DVI-I (1), DP (2), Stereo (1)

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

• Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision™ technology, 3D DLP, Interleaved, and other 3D stereo format support

Full OpenGL guad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

Shading Architecture

Supported Graphics APIs

Shader Model 5.0 OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

**Available Graphics** 

**Drivers** 

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

**Power Consumption** 152 Watts



#### Technical Specifications - Graphics

NVIDIA Quadro 6000 6GB Graphics Card

Form Factor 4.376" H x 9.75" L

**Dual Slot** 

**Graphics Controller** NVIDIA Quadro 6000 Graphics Card

**Bus Type** PCI Express 2.0 x16 6 GB GDDR5 Memory

384-bit **ECC Memory** 

Connectors 1 DVI-I output, 2 DisplayPort outputs, 1 Stereo(3-pin mini DIN);

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to dual link DVI adapters

available as accessories

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

**Image Quality Features** 

• 30-bit color

Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

128-bit floating point performance

32-bit per-component floating point texture filtering and blending

64x full scene antialiasing (FSAA) / 128x FSAA in SLI Mode

Support for any combination of two connected displays

DisplayPort 1.1a, HDMI 1.3a, and HDCP support

NVIDIA 3D Vision<sup>™</sup> technology, 3D DLP, Interleaved, and other 3D stereo format support

Full OpenGL guad buffered stereo support

Underscan/overscan compensation and hardware scaling

NVIDIA nView® multi-display technology

Shading Architecture

Shader Model 5.0

Supported Graphics APIs

OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

<250 Watts **Power Consumption** 



### Technical Specifications - High Performance GPU Computing

NVIDIA Tesla C2075 Compute Processor Form Factor 4.376 inches by 9.75 inches

**Dual Slot** 

System Interface PCI Express Gen2 ×16
Video Outputs One Dual Link DVI-I

(Entry graphics level of performance)

Supported APIs CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Supported Operating

Systems

Genuine Windows 7 Professional (64-bit) Genuine Windows Vista Business (64-bit) Microsoft Windows XP Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores448 CUDA coresPower Consumption $\sim 215 \text{ Watts}$ 

NOTE 1: A 1110W PSU is required for Tesla C2075 on the Z800 NOTE 2: A 600W PSU is required for Tesla C2075 on the Z400 NOTE 3: A 1125W PSU is required for Tesla C2075 on the Z820

Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Speakers

Frequency Response (- 3dB, 24-bit/96kHz input)

FO to 20kHz

**Dimensions** Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker



### Technical Specifications - Optical and Removable Storage

HP DVD-ROM Drive Description 5.25-inch, half-height, tray-load Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

**Access Times DVD-ROM Single Layer** < 140 ms (typical)

> CD-ROM Mode 1 < 125 ms (typical) Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Source Power SATA DC power receptacle

> DC Power Requirements  $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC - < 1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

10% to 90% Relative Humidity Maximum Wet Bulb 86° F (30° C)

**Temperature** 

**Operating Systems** 

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64\*, Windows Vista

Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or

Windows XP Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

HP DVD+/-RW Drive

Description

5.25-inch, half-height, tray-load

Mounting Orientation

Either horizontal or vertical

Interface Type

SATA/ATAPI

Dimensions (WxHxD)

15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats

DVD-RAM DVD+RDVD+RWDVD+R DL DVD-R DL DVD-R

DVD-RW



Technical Specifications - Optical and Removable Storage

CD-R	
CD-RW	

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

**DVD ROM Read** DVD-RAM Up to 12X

DVD+RWUp to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+RUp to 16X DVD-R Up to 16X

Power SATA DC power receptacle

DC Power Requirements  $\,$  5 VDC  $\pm$  5%-100 mV ripple p-p

12 VDC  $\pm$  5%-200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, <1600 mA

maximum

12 VDC - <600 mA typical, <1400 mA

maximum

10% to 90%

86° F (30° C)

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity
Maximum Wet Bulb

Temperature

Operating Systems Supported Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*,

Windows 2000, Windows XP Professional or

Windows XP Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6

Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the operating system.

Kit Contents HP SATA SuperMulti DVD Writer Drive, Roxio

Easy Media Creator software, Intervideo WinDVD Software, installation guide, and

DVD+R media.

Technical Specifications - Optical and Removable Storage

HP Slot Load DVD+/-RW Description

Drive

Slim-Line, Slot-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA

Dimensions (WxHxD)  $12.7 \times 1.2 \times 12.9 \text{ cm} (5 \times 0.5 \times 5 \text{ in})$ 

Disc Formats DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R

CD-RW

Disc Capacity DVD-ROM 5/9/10/18 G DVD-Single / Dual (PTP, OTP)

(Read Only)

4.7G DVD±R/RW (Read & Write) DVD±R Dual (Read & Write)

80mm DVD

DVD-RAM (Read & Write)

CD-ROM 650 MB CD-ROM (Read Only)

80mm CD

800/700/650/ CD-Recordable (Read & Write) 700/650MB CD-Rewritable (Read & Write) 700/650MB High Speed CD-Rewritable (Read &

700/650MB Ultra & Ultra + Speed CD-

Rewritable (Read & Write)

Full Stroke DVD < 270 ms (seek) Full Stroke CD < 250 ms (seek)

Maximum Data Transfer Rates

**DVD ROM Read** 

CD ROM Read CD-ROM, CD-R and CD-RW Up to 24X

DVD-RAM Up to 5X DVD Single layer Up to 8X

DVD Dual Layer up to 6X

Power Source SATA DC power receptacle

> DC Power Requirements  $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

DC Current 5 VDC 40 mA typical, 800 mA maximum

Operating Environmental Temperature (all conditions non-

condensing)

41° to 122° F (5° to 50° C)

10% to 90% Relative Humidity

**Operating Systems** 

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Supported

Windows XP Professional or Windows XP Home

32\*.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6

Desktop/Workstation,

SUSE Linux Enterprise Desktop 10 & 11, No driver is required for this device. Native support is provided by the operating system.

Kit Contents Factory integrated only. Not available as a kit.

HP Blu-Ray Writer Description 5.25-inch, half-height, tray-load

Either horizontal or vertical Mounting Orientation

Interface Type SATA

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)



Technical Specifications - Optical and Removable Storage

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Disc Formats	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-R			
Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB st	5 GB DL or 4.7 GB standard	
. ,	Blu-ray	50 GB DL or 25 GB standard < 250 ms (seek) < 210 ms (seek) <275 ms (seek)		
	Full Stroke DVD			
	Full Stroke CD			
	Blu-ray			
	Startup Time (Time to	BD-ROM (SL/DL)	25\$ / 28\$	
	drive ready from tray	BD-R (SL/DL)	25\$ / 28\$	
	loading)	BD-RE (SL/DL)	25\$ / 28\$	
		DVD-ROM (SL/DL)	185 / 185	
		DVD-R (SL/DL)	25\$ / 25\$	
		DVD-RW	25\$	
		DVD+R (SL/DL)	25\$ / 25\$	
		DVD+RW	25\$	
		DVD-RAM	45S	
		CD-ROM	45S	
Maximum Data Transfer	CD ROM Read	CD-ROM	Up to 40X	
Rates		CD-R	Up to 40X	
	DVD DOM D I	CD-RW	Up to 40X	
	DVD ROM Read	DVD-RAM	Up to 5X	
		DVD+RW	Up to 10X	
		DVD-RW DVD+R DL	Up to 10X Up to 8X	
		DVD+R DL DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 12X	
		DVD-R	Up to 12X	
	Blu-Ray	BD-ROM	Up to 6X	
	,	BD-ROM DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-R DL	Up to 4.8X	
		BD-R	Up to 6X	
			•	

Technical Specifications - Optical and Removable Storage

BD-RE SL/DL Up to 4.8X

Power Source SATA DC power receptacle

> DC Power Requirements  $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

12 VDC ± 10%-100 mV ripple p-p

DC Current 5 VDC -900 mA typical, 1200 mA maximum

> 12 VDC -1000 mA typical, 1600 mA maximum 41° to 122° F (5° to 50° C)

Operating Environmental Temperature

(all conditions noncondensing)

Relative Humidity 15% to 80% Maximum Wet Bulb 86° F (30° C)

**Temperature** 

**Operating Systems** 

Supported

Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or

Windows XP Home 32\*.

Red Hat Enterprise Linux(RHEL) WS4\*\*, 5, 6

Desktop/Workstation,

SUSE Linux Enterprise Desktop 10 & 11

\* No driver is required for this device. Native support is provided by the operating system.

\*\* RHEL WS4 not supported on Z200/Z200SFF

Kit Contents HP Blue Laser RW Drive, Roxio Easy Media

Creator software, Intervideo WinDVD Software,

installation guide.

Disclaimer As Blu-Ray is a new format containing new technologies, certain disc, digital

> connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support.

HD-DVD movies cannot be played on this workstation.

#### Technical Specifications - Optical and Removable Storage

HP 22-in-1 Media Card Description

Reader

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.

Mounting Orientation

The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if the chassis provides one) or in an appropriate Optical Bay adapter. It will

operate in any orientation.

Interface Type

USB 2.0 (one channel dedicated to the separate USB port; one channel

dedicated to the flash memory card slots)

124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)

Dimensions (WxHxD)

Disc Formats xD-Picture

Micro SD

Micro SDHC

SD **SDHC SDXC** Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro

Memory Stick Micro (M2)

HP DX115 Removable **Drive Enclosure** 

Interface Type

Compatible with SAS or SATA controllers

Dimensions (WxHxL)

147.6 x 41.1 x 205 mm (5.81 x 1.62 x 8.08 in)

Weight

Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)

### Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCle Card

Data Transfer Rate **Devices Supported** 

Supports up to 800 Mbps IEEE-1394 compliant devices

PCIe card full height PCIe slots **Bus Type** 

**Ports** Two IEEE-1394b bilingual 9-Pin connectors (Rear)

Internal Connectors One 10-Pin Header connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

> Professional, Windows XP Home, Windows Vista, SLED 11 and RHEL 6. Intel Pentium® G series or higher processor, 128-MB RAM, 1-GB Hard Drive,

CD-ROM drive, built in sound system, Available PCle slot.

Temperature – Operating 50° to 131° F (10° to 55° C)

Temperature – Storage Relative Humidity -

-22° to 140° F (-30° to 60° C)

20% to 80%

Operating Compliances

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

**Operating Systems** 

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit

and 64-bit, Windows® XP Professional, XP Professional 64-bit, RHEL 6 and

SLED 11.

#### Technical Specifications - Networking and Communications

Integrated Intel 82579LM Connector RJ-45

PCIe GbE Controller

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1P, 802.1Q, 802.2, 802.3, 802.3ab, 802.3az, 802.3u

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCle-based interface for active state operation (S0 state) and SMBus for host

and management traffic (Sx low power state)

**Power Requirement** Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable

diagnostic.

AMT 7.0 support

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware Certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for

Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity

**Dimensions** 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible



Technical Specifications - Networking and Communications

Operating System Driver Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1,

Support Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64

Red Hat Enterprise Linux (RHEL) 5, 6; Novell SLED 10 & 11

Management Capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install

guide, product warranty statement

Intel Gigabit CT Desktop Connector NIC Controller

Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)
Operating Humidity 85% at 131° F (55° C)

**Dimensions** 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64,

Windows Vista Business 32, Windows XP Professional, Windows XP x64.
Red Hat Enterprise Linux 4 (RHEL4.8 or newer)\*, Red Hat Enterprise Linux 5 (RHEL5.3 or newer), Red Hat Enterprise Linux 6, SUSE Linux Enterprise

Desktop (SLED) 11

RHEL 4 and 5, SLED 10, are not supported on the Z220 CMT/SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement

#### Technical Specifications - Networking and Communications

HP NC360T PCI Express Dual Port Gigabit NIC Connector Two RJ-45
Controller Intel 82571EB
Memory Integrated 96KB
Data Rates Supported 10/100/1000 Mbps

Compliance 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q

Bus Architecture PCI-E 1.0a

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express slots

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC Class B, VCCI Class B, BSMI Class A, CISPR 22 Class B, EN 55022

Class B, EN55024-1, ICES-003 Class B, MIC Class B, ACA Class B, UL,

Canada UL, EN60950

Power Requirement 1280 mA @ 3.3V typical

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature  $32^{\circ}$  to  $131^{\circ}$ F (0° to  $55^{\circ}$  C) Operating Humidity 0% to 95% non-condensing Dimensions  $12.95 \times 6.8$  cm  $(5.1 \times 2.7$  in)

Operating System Driver

Support

Windows Vista Business 64, Windows Vista Business 32, Windows XP

Professional, Windows XP Professional x64 Edition.

Red Hat Enterprise Linux(RHEL) WS4, 5, 6 Desktop/Workstation

Novell SLED 10 & SLED 11

Management Capabilities WOL , PXE 2.1

Kit Contents HP NC360T PCI Express Dual Port Gigabit NIC, low profile bracket, CD

containing Intel PROset II NIC drivers, quick install guide, product warranty

statement

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